

Preliminary Amendment

Applicant: Gerold Gruender, et al.
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Docket No.: I431.174.101/FIN565PCT/US
Title: **COOLING SYSTEM FOR DEVICES HAVING POWER SEMICONDUCTORS AND METHOD
FOR COOLING THE DEVICE (as amended)**

IN THE ABSTRACT

Please replace the Abstract with the following rewritten paragraph:

**COOLING SYSTEM FOR DEVICES COMPRISING HAVING POWER
SEMICONDUCTORS AND METHOD FOR COOLING SAID TYPE OF THE
DEVICE**

~~The invention relates to a~~ A cooling system (22) for devices ~~comprising having~~ power semiconductors (1) and a method for cooling ~~said type of the device is disclosed. For this purpose~~ In one embodiment, the cooling system has printed circuit boards (4) arranged on a circuit carrier (10) in plug-in contact strips (7). The cooling system itself has a cooling plate (11), which is mounted in a pivotable manner on one of the plug-in contact strips (7) in the region of the power semiconductor component (1). The cooling plate (11) can be pivoted about an axis (14) in such a way that it assumes a first position, which is pivoted away from the printed circuit board (4), and a second position, in which the cooling plate (11) bears on the power semiconductor component (1).

~~[Figure 1]~~